

# PC456L0NIP

\* VDE (VDE0884) approved type is also available as an option

## ■ Features

1. High resistance to noise (CMR:MIN. 15kV/μs)
2. High speed response  
( $t_{PHL}$ :MAX.400ns,  $t_{PLH}$ :MAX.550ns)
3. Mini-flat package
4. Isolation voltage ( $V_{iso(rms)}$ ):3.75kV)
5. Recognized by UL, file No. E64380 (Model No. PC456L)

## ■ Applications

1. Programmable controller
2. Inverter

## ■ Absolute Maximum Ratings

 ( $T_a=25^\circ\text{C}$ )

	Parameter	Symbol	Rating	Unit
Input	*1 Forward current	$I_F$	25	mA
	Reverse voltage	$V_R$	5	V
	*2 Power dissipation	P	45	mW
Output	Supply voltage	$V_{CC}$	-0.5 to +35	V
	Output voltage	$V_O$	-0.5 to +35	V
	Output current	$I_O$	15	mA
	*3 Power dissipation	$P_O$	100	mW
	*4 Isolation voltage	$V_{iso(rms)}$	3.75	kV
	Operating temperature	$T_{opr}$	-40 to +100	$^\circ\text{C}$
	Storage temperature	$T_{stg}$	-40 to +125	$^\circ\text{C}$
	*5 Soldering temperature	$T_{sol}$	270	$^\circ\text{C}$

\*1 When ambient temperature goes above  $70^\circ\text{C}$ , the power dissipation goes down at  $0.45\text{mA}/^\circ\text{C}$ .

\*2 When ambient temperature goes above  $70^\circ\text{C}$ , the power dissipation goes down at  $0.8\text{mW}/^\circ\text{C}$ .

\*3 When ambient temperature goes above  $70^\circ\text{C}$ , the power dissipation goes down at  $1.8\text{mW}/^\circ\text{C}$ .

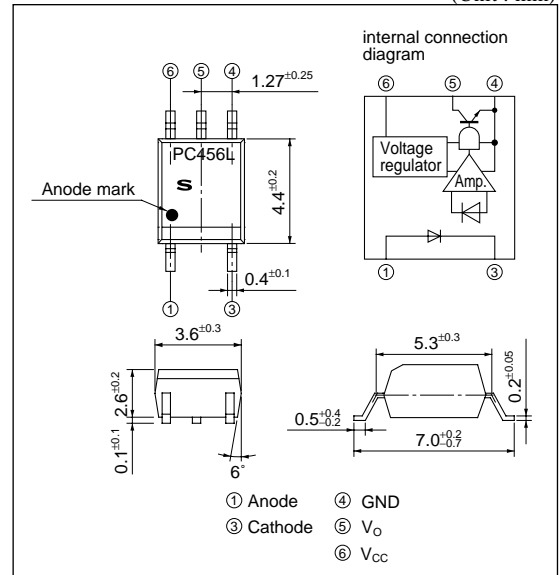
\*4 40 to 60%RH, AC for 1minute

\*5 For 10s

## High Speed and High CMR \*OPIC Photocoupler

### ■ Outline Dimensions

(Unit : mm)



\* "OPIC" (Optical IC) is a trademark of the SHARP Corporation. An OPIC consists of a light-detecting element and signal-processing circuit integrated onto a single chip.

## ■ Electro-optical Characteristics <sup>\*6</sup> (unless otherwise specified $T_a=-40$ to $100^\circ\text{C}$ , $V_{CC}=4.5$ to $35\text{V}$ )

Parameter		Symbol	Conditions	MIN.	TYP.	MAX.	Unit	
Input	Forward voltage	$V_F$	$T_a=25^\circ\text{C}$ , $I_F=10\text{mA}$	–	1.6	1.95	V	
	Reverse current	$I_R$	$T_a=25^\circ\text{C}$ , $V_R=5\text{V}$	–	–	10	$\mu\text{A}$	
	Terminal capacitance	$C_t$	$T_a=25^\circ\text{C}$ , $V_R=0$ , $f=1\text{MHz}$	–	60	250	pF	
Output	Operating supply voltage	$V_{CC}$	–	4.5	–	35	V	
	Low level output voltage	$V_{OL}$	$I_F=10\text{mA}$ , $I_O=2.4\text{mA}$	–	0.3	0.6	V	
	Low level output current	$I_{OL}$	$I_F=10\text{mA}$ , $V_O=0.6\text{V}$	4.4	9	–	mA	
	High level output current	$I_{OH}$	$I_F=0$ , $V_{CC}=V_O$	–	5	50	$\mu\text{A}$	
	High level supply current	$I_{CCH}$	$I_F=0$ , $V_O=\text{OPEN}$	–	0.6	1.3	mA	
	Low level supply current	$I_{CCL}$	$I_F=10\text{mA}$ , $V_O=\text{OPEN}$	–	0.8	1.3	mA	
Transfer characteristics	"High→Low" threshold input current	$I_{FHL}$	$V_O=0.8\text{V}$ , $R_L=20\text{k}\Omega$ , $V_{CC}=15\text{V}$	–	1.5	5	mA	
	Isolation resistance	$R_{ISO}$	$T_a=25^\circ\text{C}$ , $\text{DC}500\text{V}$ , 40 to 60%RH	$5 \times 10^{10}$	$10^{11}$	–	$\Omega$	
	Floating capacitance	$C_f$	$T_a=25^\circ\text{C}$ , $V=0$ , $f=1\text{MHz}$	–	0.6	1	pF	
	Response time	<sup>*8</sup> "High→Low" propagation time	$t_{PHL}$	$I_F=10\text{mA}$ ( $t_{PHL}$ ), $I_i=0$ ( $t_{PLH}$ ), $V_{CC}=15\text{V}$ , $R_L=20\text{k}\Omega$ , $C_L=100\text{pF}$ $V_{THLH}=2.0\text{V}$ , $V_{THHL}=1.5\text{V}$	30	210	400	ns
		<sup>*8</sup> "Low→High" propagation time	$t_{PLH}$		270	400	550	ns
		<sup>*7</sup> Distortion of pulse width	$\Delta\text{tw}$		–	190	450	ns
	Propagation delay difference between any two parts	$T_{PSK}$	–150		200	450	ns	
CMR	<sup>*9</sup> Instantaneous common mode rejection voltage "Output : High level"	$\text{CM}_H$	$T_a=25^\circ\text{C}$ , $I_F=0$ , $V_{CC}=15\text{V}$ , $C_L=100\text{pF}$ , $V_{CM}=1.5\text{kV}_{(P-P)}$ , $R_L=20\text{k}\Omega$ , $V_O>3.0\text{V}$	15	30	–	kV/ $\mu\text{s}$	
	<sup>*9</sup> Instantaneous common mode rejection voltage "Output : Low level"	$\text{CM}_L$	$T_a=25^\circ\text{C}$ , $I_F=10\text{mA}$ , $V_{CC}=15\text{V}$ , $C_L=100\text{pF}$ , $V_{CM}=1.5\text{kV}_{(P-P)}$ , $R_L=20\text{k}\Omega$ , $V_O<1.0\text{V}$	–15	–30	–	kV/ $\mu\text{s}$	

<sup>\*6</sup> It shall connect a by-pass capacitor of  $0.01\mu\text{F}$  or more between  $V_{CC}$  (Pin ⑥) and GND (Pin ③) near the device, when it measures the transfer characteristics and the output side characteristics

<sup>\*7</sup> Distortion of pulse width  $\Delta\text{tw} = |t_{PHL} - t_{PLH}|$

<sup>\*8</sup> Refer to Fig.1

<sup>\*9</sup> Refer to Fig.2

## ■ Recommended Operating Conditions

Parameter	Symbol	MIN.	MAX.	Unit
Forward current	$I_F$	10	20	mA
Supply voltage	$V_{CC}$	4.5	35	V
Output voltage	$V_O$	0	35	V
Operating temperature	$T_{opr}$	–40	100	$^\circ\text{C}$

Fig.1 Test Circuit for  $t_{PHL}$  and  $t_{PLH}$

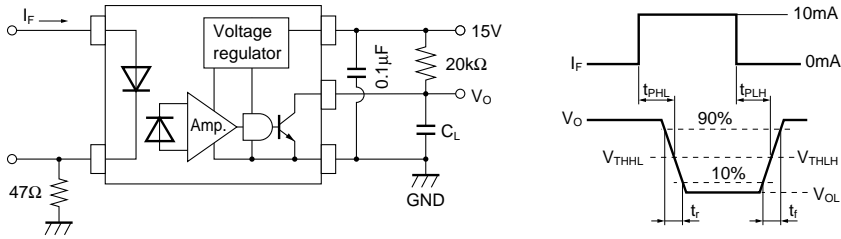


Fig.2 Test Circuit for  $CM_H$  and  $CM_L$

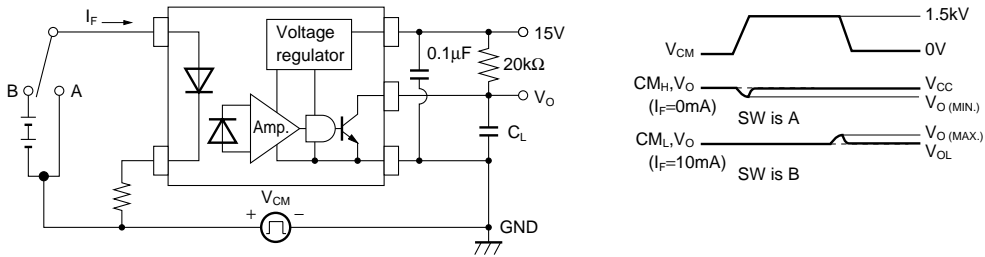


Fig.3 Forward Current vs. Ambient Temperature

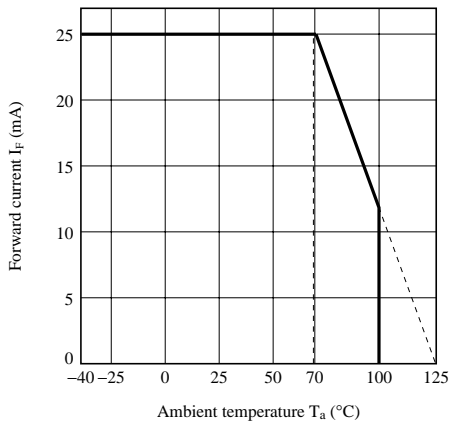


Fig.4 Power Dissipation vs. Ambient Temperature

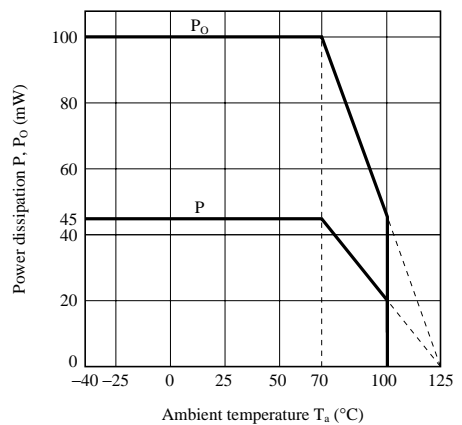


Fig.5 Output Current vs. Forward Current

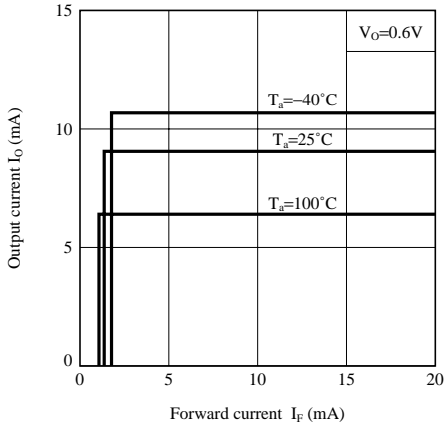


Fig.6 Forward Current vs. Forward Voltage

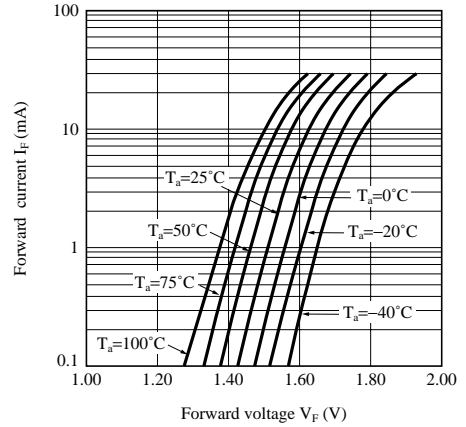


Fig.7 Relative Output Current vs. Ambient Temperature

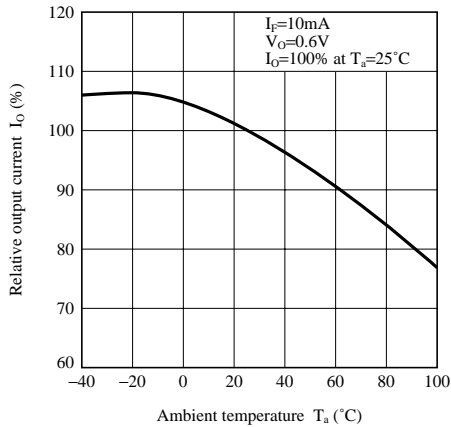


Fig.8 Threshold Input Current vs. Ambient Temperature

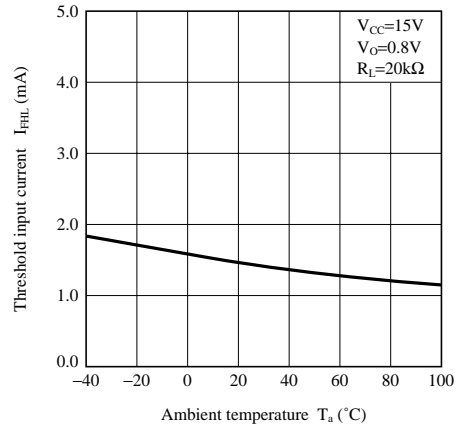


Fig.9 Low Level Output Voltage vs. Ambient Temperature

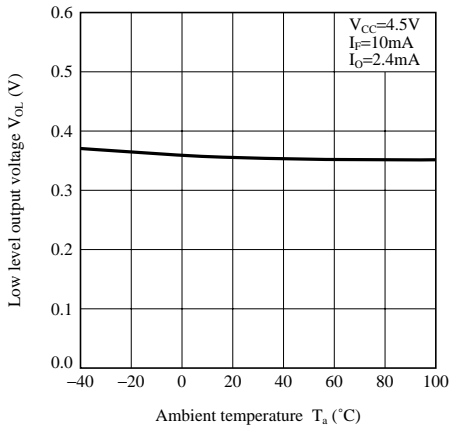
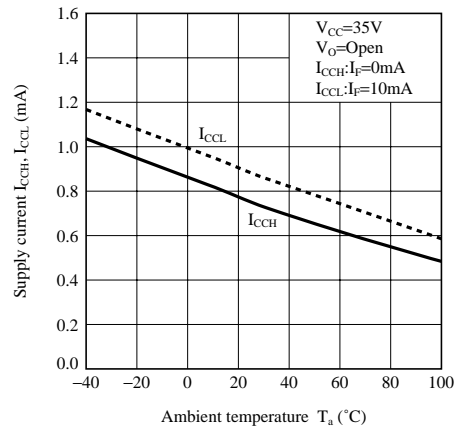
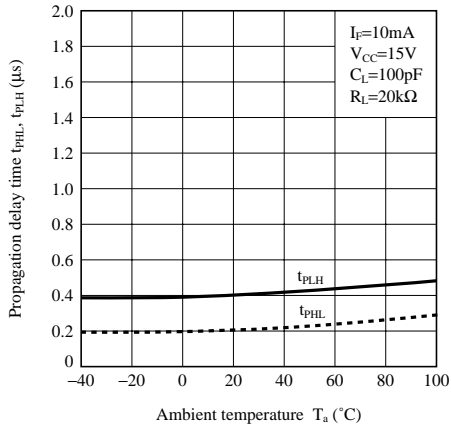


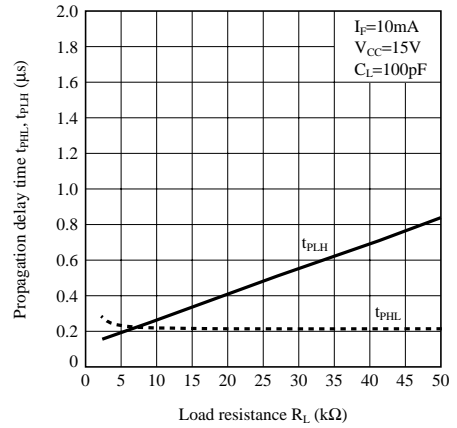
Fig.10 Supply Current vs. Ambient Temperature



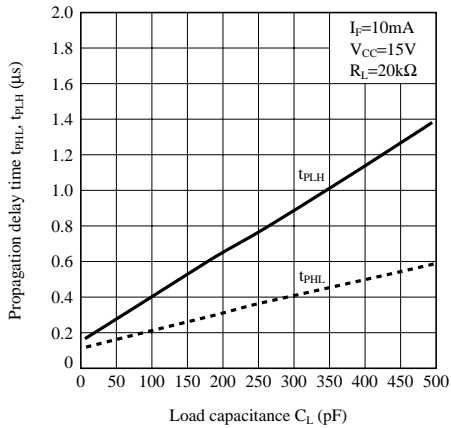
**Fig.11 Propagation Delay Time vs. Ambient Temperature**



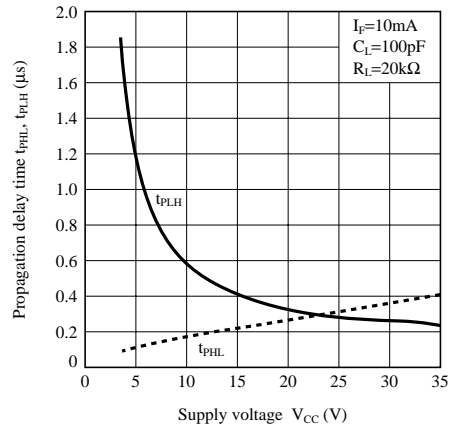
**Fig.12 Propagation Delay Time vs. Load Resistance**



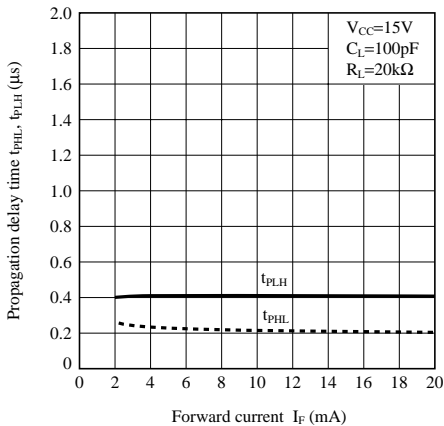
**Fig.13 Propagation Delay Time vs. Load Capacitance**



**Fig.14 Propagation Delay Time vs. Supply Voltage**



**Fig.15 Propagation Delay Time vs. Forward Current**



## NOTICE

- The circuit application examples in this publication are provided to explain representative applications of SHARP devices and are not intended to guarantee any circuit design or license any intellectual property rights. SHARP takes no responsibility for any problems related to any intellectual property right of a third party resulting from the use of SHARP's devices.
- Contact SHARP in order to obtain the latest device specification sheets before using any SHARP device. SHARP reserves the right to make changes in the specifications, characteristics, data, materials, structure, and other contents described herein at any time without notice in order to improve design or reliability. Manufacturing locations are also subject to change without notice.
- Observe the following points when using any devices in this publication. SHARP takes no responsibility for damage caused by improper use of the devices which does not meet the conditions and absolute maximum ratings to be used specified in the relevant specification sheet nor meet the following conditions:
  - (i) The devices in this publication are designed for use in general electronic equipment designs such as:
    - Personal computers
    - Office automation equipment
    - Telecommunication equipment [terminal]
    - Test and measurement equipment
    - Industrial control
    - Audio visual equipment
    - Consumer electronics
  - (ii) Measures such as fail-safe function and redundant design should be taken to ensure reliability and safety when SHARP devices are used for or in connection with equipment that requires higher reliability such as:
    - Transportation control and safety equipment (i.e., aircraft, trains, automobiles, etc.)
    - Traffic signals
    - Gas leakage sensor breakers
    - Alarm equipment
    - Various safety devices, etc.
  - (iii) SHARP devices shall not be used for or in connection with equipment that requires an extremely high level of reliability and safety such as:
    - Space applications
    - Telecommunication equipment [trunk lines]
    - Nuclear power control equipment
    - Medical and other life support equipment (e.g., scuba).
- If the SHARP devices listed in this publication fall within the scope of strategic products described in the Foreign Exchange and Foreign Trade Law of Japan, it is necessary to obtain approval to export such SHARP devices.
- This publication is the proprietary product of SHARP and is copyrighted, with all rights reserved. Under the copyright laws, no part of this publication may be reproduced or transmitted in any form or by any means, electronic or mechanical, for any purpose, in whole or in part, without the express written permission of SHARP. Express written permission is also required before any use of this publication may be made by a third party.
- Contact and consult with a SHARP representative if there are any questions about the contents of this publication.